



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
Q1	20V	0.45Ω @ V _{GS} = 4.5V	1066mA
Q2	200	0.75Ω @ V _{GS} = -4.5V	-845mA

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Up to 2.5kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

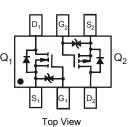
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)









Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMG1016UDW-7	Standard	SOT363	3000/Tape & Reel
DMG1016UDWQ-7	Automotive	SOT363	3000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:

<u> </u>				
	CA1	ΥM	CA1	×W
ode Ke	y y			
ear	2008	2009	2010	2011
de	V	W	Х	Y

CA1 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site) \overline{YM} = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or \overline{Y} = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Ke	y											
Year	2008	20	09	2010	2011	20)12	2013	2014	20	15	2016
Code	V	V	V	Х	Y		Z	А	В	(0	D
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	330	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ ext{ heta}JA}$	379	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±6	V
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	I _D	1066 690	mA

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±6	V
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	I _D	-845 -548	mA

Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	V _{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}$	C I _{DSS}	_	_	100	nA	V _{DS} =20V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±1.0	μA	V_{GS} = ±4.5V, V_{DS} = 0V
ON CHARACTERISTICS (Note 6)					•	
Gate Threshold Voltage	V _{GS(th)}	0.5		1.0	V	V_{DS} = V_{GS} , I_D = 250 μ A
		—	0.3	0.45		V_{GS} = 4.5V, I _D = 600mA
Static Drain-Source On-Resistance	R _{DS(ON)}		0.4	0.6	Ω	V_{GS} = 2.5V, I_{D} = 500mA
			0.5	0.75		V _{GS} = 1.8V, I _D = 350mA
Forward Transfer Admittance	Y _{fs}	_	1.4	_	S	V _{DS} = 10V, I _D = 400mA
Diode Forward Voltage (Note 6)	V _{SD}	—	0.7	1.2	V	V _{GS} = 0V, I _S = 150mA
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	—	60.67	—	pF	
Output Capacitance	Coss	—	9.68	—	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	5.37	_	pF	1 - 1.01011Z
Total Gate Charge (4.5V)	Qg	—	736.6	_	nC	
Gate-Source Charge	Q _{gs}	—	93.6	_	nC	V _{GS} = 4.5V, V _{DS} = 10V, I _D = 250mA
Gate-Drain Charge	Q _{gd}	—	116.6	—	nC	
Turn-On Delay Time	t _{D(on)}	—	5.1	—	ns	
Turn-On Rise Time		—	7.4	—	ns	V _{DD} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time	t _{D(off)}	—	26.7		ns	$R_L = 47\Omega, R_G = 10\Omega,$
Turn-Off Fall Time	t _f	—	12.3		ns]

5. Device mounted on FR-4 PCB with minimum recommended pad layout.

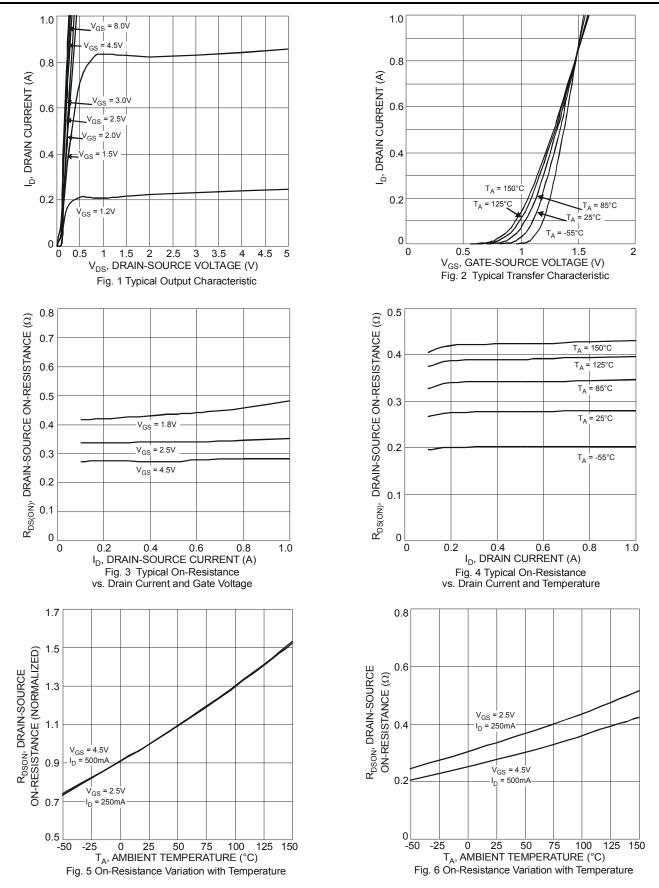
6. Short duration pulse test used to minimize self-heating effect.

7. Guaranteed by design. Not subject to production testing.

Notes:

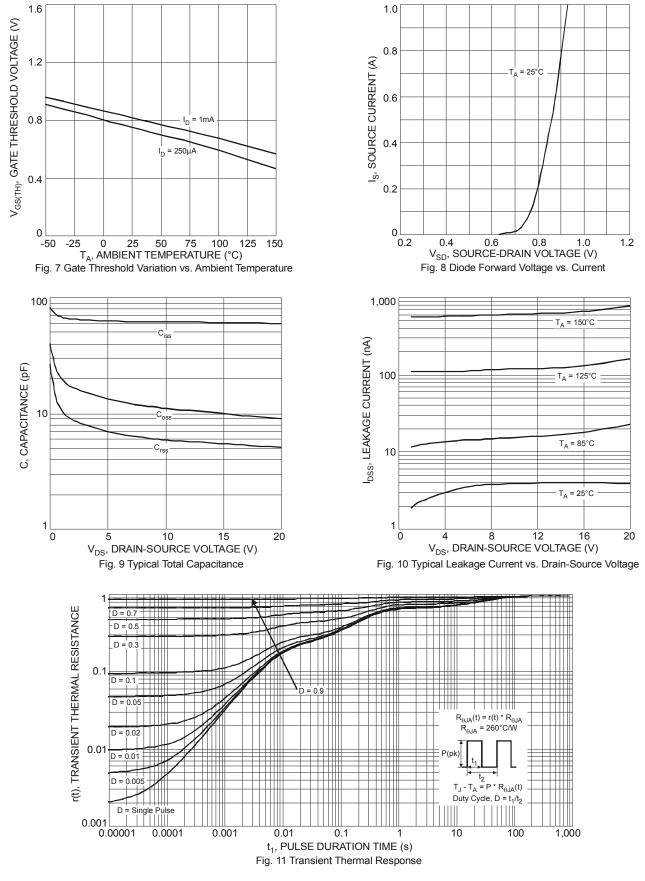


N-CHANNEL – Q1





N-CHANNEL – Q1 (cont.)



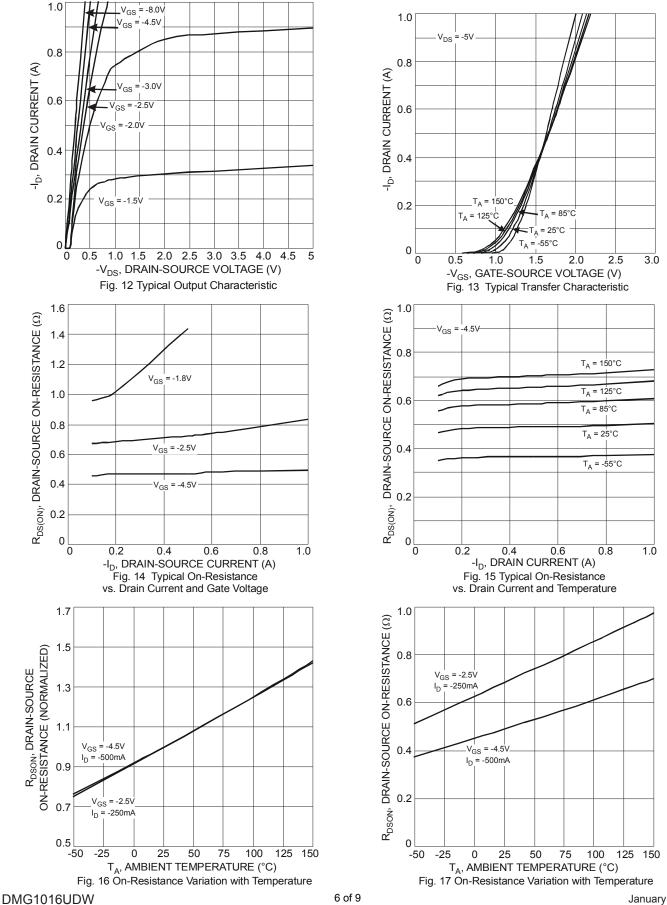


Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20		—	V	V _{GS} = 0V, I _D = -250µA
Zero Gate Voltage Drain Current @Tc = +25°	C I _{DSS}	_	—	-100	nA	V _{DS} = -20V, V _{GS} = 0V
Gate-Source Leakage		_	—	±2.0	μA	V_{GS} = ±4.5V, V_{DS} = 0V
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(th)}	-0.5	_	-1.0	V	V_{DS} = V_{GS} , I_D = -250 μ A
			0.5	0.75		V_{GS} = -4.5V, I _D = -430mA
Static Drain-Source On-Resistance	R _{DS (ON)}		0.7	1.05	Ω	V_{GS} = -2.5V, I _D = -300mA
			1.0	1.5		V _{GS} = -1.8V, I _D = -150mA
Forward Transfer Admittance	Y _{fs}		0.9	—	S	V_{DS} = -10V, I_{D} = -250mA
Diode Forward Voltage (Note 6)	V _{SD}		-0.8	-1.2	V	V _{GS} = 0V, I _S = -150mA
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss		59.76	—	pF	
Output Capacitance	Coss		12.07	—	pF	V _{DS} = -16V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		6.36	_	pF	
Total Gate Charge (4.5V)	Qg		622.4	_	pC	
Gate-Source Charge	Q _{gs}		100.3	_	pC	$V_{GS} = -4.5V, V_{DS} = -10V,$
Gate-Drain Charge	Q _{gd}	—	132.2	—	рС	$-I_{\rm D} = -250 {\rm mA}$
Turn-On Delay Time	t _{D(on)}	_	5.1	—	ns	
Turn-On Rise Time			8.1	—	ns	V _{DS} = -10V, V _{GS} = -4.5V,
Turn-Off Delay Time	t _{D(off)}	_	28.4	—	ns	R_G = 10 Ω , R_L = 47 Ω
Turn-Off Fall Time	t _f	_	20.72	_	ns	7

6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to production testing Notes:

P-CHANNEL – Q2

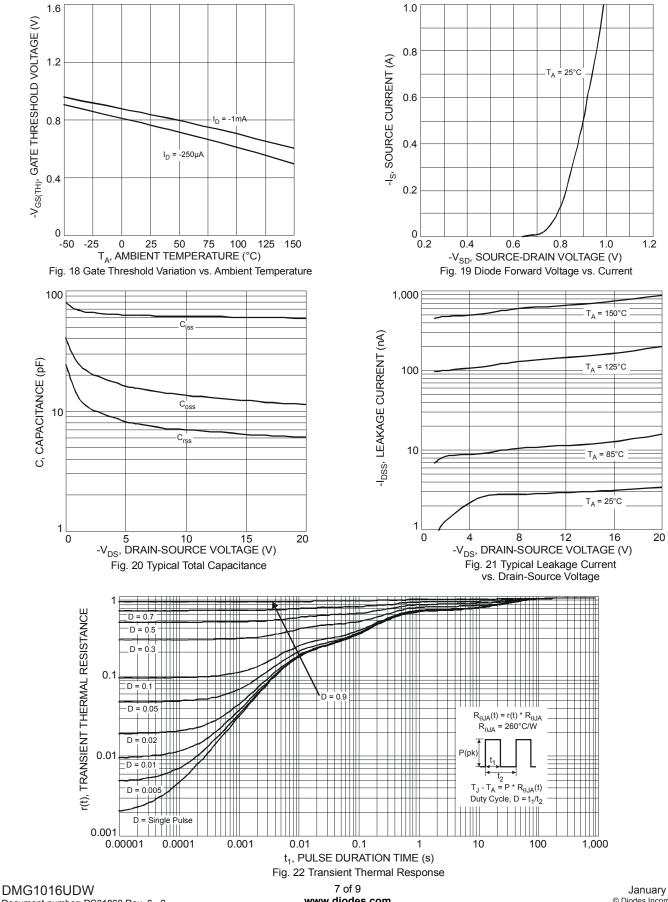


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P-CHANNEL - Q2 (cont.)

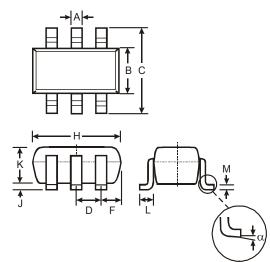


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Package Outline Dimensions

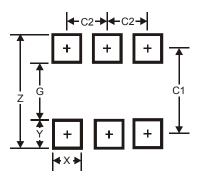
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT363					
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65	Тур			
F	0.40	0.45			
Н	1.80	2.20			
J	0	0.10			
κ	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Di	mensions	in mm			

Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



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